

Cont  
a,  
the thickness of the adhesive layer 6 is not set less than the particle diameter of the  
conductive filler, the conductive filler does not break through the adhesive layer 6 to  
abut surely against the external electrode 3 and causes a poor conduction. For such a  
reason, the thickness of the adhesive layer 6 is set less than the particle diameter of the  
conductive filler contained in the connecting element 5.--

**IN THE CLAIMS:**

Please delete claims 5 and 10-17, without prejudice, and amend claims 1, 6 and  
9 to read as follows:

A2 Sub B1  
1. (Amended) An electronic part comprising:  
an external electrode; and  
a coating including a thermoplastic or thermosetting resin disposed on a surface  
of said external electrode.

A3  
6. (Amended) An electronic part mounting element comprising:  
an electronic part;  
a coating containing a resin ingredient and formed on a surface of an external  
electrode of said electronic part;  
an element to be mounted with said electronic part; and  
a conductive adhesive containing a conductive filler for electrically connecting  
the external electrode of said electronic part to a connecting terminal of said element to  
be mounted,

cmnt  
A3  
wherein the thickness of said coating is less than the particle diameter of said  
conductive filler.

A4  
Sub  
B3  
9. (Amended) An electronic part mounting element comprising:  
an external electrode;  
a coating of a conductive adhesive containing a conductive filler formed on the  
entire surface of the external electrode of the electronic part,  
wherein said external electrode of said electronic part is electrically connected to  
a connecting terminal of an element on which said electronic part is to be mounted, said  
coating operative as a connecting element for connecting said external electrode to  
said connecting terminal.

Please add new claims 18-27 as follows:

A5  
--18. An electronic part comprising:  
an external electrode;  
a coating including a thermoplastic or thermosetting resin ingredient is provided  
disposed on a surface of said external electrode; and  
a conductive filler is disposed on said coating;  
wherein the thickness of said coating is less than the particle diameter of said  
conductive filler.

Sub  
B4  
19. The electronic part as set forth in claim 1, wherein the surface roughness  
(Ra) of said external electrode of is in the range of 0.1  $\mu$ m to 10.0  $\mu$ m.

20. The electronic part mounting element as set forth in claim 6, wherein the surface roughness (Ra) of said external electrode of is in the range of 0.1 m to 10.0 m.

21. The electronic part mounting element as set forth in claim 9, wherein the surface roughness (Ra) of said external electrode of is in the range of 0.1 m to 10.0 m.

22. The electronic part as set forth in claim 18, wherein the surface roughness (Ra) of said external electrode of is in the range of 0.1 m to 10.0 m.

23. The electronic part as set forth in claim 1, wherein the surface roughness (Ra) of said external electrode of is in the range of 0.1 m to 5.0 m.

24. The electronic part mounting element as set forth in claim 6, wherein the surface roughness (Ra) of said external electrode of is in the range of 0.1 m to 5.0 m.

25. The electronic part mounting element as set forth in claim 9, wherein the surface roughness (Ra) of said external electrode of is in the range of 0.1 m to 5.0 m.

26. The electronic part as set forth in claim 18, wherein the surface roughness (Ra) of said external electrode of is in the range of 0.1 m to 5.0 m.

27. The electronic part as set forth in claim 1, wherein said coating is disposed over the entire surface of said external electrode.--

## REMARKS

### I. Introduction

In response to the pending Office Action, Applicants have cancelled claims 5 and 10-17, without prejudice, amended claims 1, 6 and 9, and added new claims 18-27.

More specifically, claim 1 was amended to recite that the coating includes a